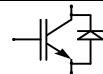


Technische Information / Technical Information

IGBT-Module
IGBT-Modules

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Elektrische Eigenschaften / Electrical properties

Höchstzulässige Werte / Maximum rated values

Diode Gleichrichter/ Diode Rectifier

Periodische Rückw. Spitzensperrspannung repetitive peak reverse voltage		V_{RRM}	1600	V
Durchlaßstrom Grenzeffektivwert RMS forward current per chip		I_{FRMSM}	40	A
Dauergleichstrom DC forward current	$T_C = 80^\circ C$	I_d	50	A
Stoßstrom Grenzwert surge forward current	$t_p = 10 \text{ ms}, T_{vj} = 25^\circ C$ $t_p = 10 \text{ ms}, T_{vj} = 150^\circ C$	I_{FSM}	500 400	A A
Grenzlastintegral I^2t - value	$t_p = 10 \text{ ms}, T_{vj} = 25^\circ C$ $t_p = 10 \text{ ms}, T_{vj} = 150^\circ C$	I^2t	1250 800	A^2s A^2s

Transistor Wechselrichter/ Transistor Inverter

Kollektor-Emitter-Sperrspannung collector-emitter voltage		V_{CES}	1200	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 80^\circ C$ $T_C = 25^\circ C$	$I_{C,nom.}$ I_C	50 70	A A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1 \text{ ms}, T_C = 80^\circ C$	I_{CRM}	100	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^\circ C$	P_{tot}	360	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		V_{GES}	+/- 20V	V

Diode Wechselrichter/ Diode Inverter

Dauergleichstrom DC forward current	$T_C = 80^\circ C$	I_F	50	A
Periodischer Spitzenstrom repetitive peak forw. current	$t_p = 1 \text{ ms}$	I_{FRM}	100	A
Grenzlastintegral I^2t - value	$V_R = 0V, t_p = 10ms, T_{vj} = 125^\circ C$	I^2t	1.200	A^2s

Transistor Brems-Chopper/ Transistor Brake-Chopper

Kollektor-Emitter-Sperrspannung collector-emitter voltage		V_{CES}	1200	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 80^\circ C$ $T_C = 25^\circ C$	$I_{C,nom.}$ I_C	25 45	A A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1 \text{ ms}, T_C = 80^\circ C$	I_{CRM}	50	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^\circ C$	P_{tot}	230	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		V_{GES}	+/- 20V	V

Diode Brems-Chopper/ Diode Brake-Chopper

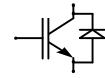
Dauergleichstrom DC forward current	$T_C = 80^\circ C$	I_F	15	A
Periodischer Spitzenstrom repetitive peak forw. current	$t_p = 1 \text{ ms}$	I_{FRM}	30	A

prepared by: A.Schulz	date of publication: 2001-11-28
approved by: M.Hierholzer	revision: 2

Technische Information / Technical Information

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Modul Isolation/ Module Isolation

Isolations-Prüfspannung insulation test voltage	RMS, f = 50 Hz, t = 1 min. NTC connected to Baseplate	V _{ISOL}	2,5	kV
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Elektrische Eigenschaften / Electrical properties

Charakteristische Werte / Characteristic values

Diode Gleichrichter/ Diode Rectifier

			min.	typ.	max.	
Durchlaßspannung forward voltage	T _{vj} = 150°C, I _F = 50 A	V _F	-	1,05	-	V
Schleusenspannung threshold voltage	T _{vj} = 150°C	V _(TO)	-	-	0,8	V
Ersatzwiderstand slope resistance	T _{vj} = 150°C	r _T	-	-	6,5	mΩ
Sperrstrom reverse current	T _{vj} = 150°C, V _R = 1600 V	I _R	-	3	-	mA
Modul Leitungswiderstand, Anschlüsse-Chip lead resistance, terminals-chip	T _C = 25°C	R _{AA+CC'}	-	4	-	mΩ

Transistor Wechselrichter/ Transistor Inverter

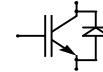
			min.	typ.	max.	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	V _{GE} = 15V, T _{vj} = 25°C, I _C = 50 A V _{GE} = 15V, T _{vj} = 125°C, I _C = 50 A	V _{CE sat}	-	3,2	3,7	V
Gate-Schwellenspannung gate threshold voltage	V _{CE} = V _{GE} , T _{vj} = 25°C, I _C = 2 mA	V _{GE(TO)}	4,5	5,5	6,5	V
Eingangskapazität input capacitance	f = 1MHz, T _{vj} = 25°C V _{CE} = 25 V, V _{GE} = 0 V	C _{ies}	-	3,3	-	nF
Kollektor-Emitter Reststrom collector-emitter cut-off current	V _{GE} = 0V, T _{vj} = 25°C, V _{CE} = 1200 V	I _{CES}	-	-	5	mA
Gate-Emitter Reststrom gate-emitter leakage current	V _{CE} = 0V, V _{GE} = 20V, T _{vj} = 25°C	I _{GES}	-	-	400	nA
Einschaltverzögerungszeit (ind. Last) turn on delay time (inductive load)	I _C = I _{Nenn} , V _{CC} = 600 V V _{GE} = ±15V, T _{vj} = 25°C, R _G = 15 Ohm V _{GE} = ±15V, T _{vj} = 125°C, R _G = 15 Ohm	t _{d,on}	-	60	-	ns
Anstiegszeit (induktive Last) rise time (inductive load)	I _C = I _{Nenn} , V _{CC} = 600 V V _{GE} = ±15V, T _{vj} = 25°C, R _G = 15 Ohm V _{GE} = ±15V, T _{vj} = 125°C, R _G = 15 Ohm	t _r	-	50	-	ns
Abschaltverzögerungszeit (ind. Last) turn off delay time (inductive load)	I _C = I _{Nenn} , V _{CC} = 600 V V _{GE} = ±15V, T _{vj} = 25°C, R _G = 15 Ohm V _{GE} = ±15V, T _{vj} = 125°C, R _G = 15 Ohm	t _{d,off}	-	340	-	ns
Fallzeit (induktive Last) fall time (inductive load)	I _C = I _{Nenn} , V _{CC} = 600 V V _{GE} = ±15V, T _{vj} = 25°C, R _G = 15 Ohm V _{GE} = ±15V, T _{vj} = 125°C, R _G = 15 Ohm	t _f	-	50	-	ns
Einschaltverlustenergie pro Puls turn-on energy loss per pulse	I _C = I _{Nenn} , V _{CC} = 600 V V _{GE} = ±15V, T _{vj} = 125°C, R _G = 15 Ohm L _S = 50 nH	E _{on}	-	6,5	-	mWs
Abschaltverlustenergie pro Puls turn-off energy loss per pulse	I _C = I _{Nenn} , V _{CC} = 600 V V _{GE} = ±15V, T _{vj} = 125°C, R _G = 15 Ohm L _S = 50 nH	E _{off}	-	3,4	-	mWs
Kurzschlußverhalten SC Data	t _P ≤ 10µs, V _{GE} ≤ 15V, R _G = 15 Ohm T _{vj} ≤ 125°C, V _{CC} = 720 V dl/dt = 4000 A/µs	I _{SC}	-	300	-	A

Technische Information / Technical Information

IGBT-Module
IGBT-Modules

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Elektrische Eigenschaften / Electrical properties

Charakteristische Werte / Characteristic values

min. typ. max.

Modulinduktivität stray inductance module		L_{CE}	-	-	100	nH
Modul Leitungswiderstand, Anschlüsse-Chip lead resistance, terminals-chip	$T_C = 25^\circ\text{C}$	$R_{\text{CC}+\text{EE}}$	-	7	-	mΩ

Diode Wechselrichter/ Diode Inverter

min. typ. max.

Durchlaßspannung forward voltage	$V_{\text{GE}} = 0\text{V}, T_{vj} = 25^\circ\text{C}, I_F = 50\text{ A}$ $V_{\text{GE}} = 0\text{V}, T_{vj} = 125^\circ\text{C}, I_F = 50\text{ A}$	V_F	-	1,75	2,15	V
Rückstromspitze peak reverse recovery current	$I_F = I_{\text{Nenn}}, -di_F/dt = 1600\text{A}/\mu\text{s}$ $V_{\text{GE}} = -10\text{V}, T_{vj} = 25^\circ\text{C}, V_R = 600\text{ V}$ $V_{\text{GE}} = -10\text{V}, T_{vj} = 125^\circ\text{C}, V_R = 600\text{ V}$	I_{RM}	-	75	-	A
Sperrverzögerungsladung recovered charge	$I_F = I_{\text{Nenn}}, -di_F/dt = 1600\text{A}/\mu\text{s}$ $V_{\text{GE}} = -10\text{V}, T_{vj} = 25^\circ\text{C}, V_R = 600\text{ V}$ $V_{\text{GE}} = -10\text{V}, T_{vj} = 125^\circ\text{C}, V_R = 600\text{ V}$	Q_r	-	5,5	-	μAs
Abschaltenergie pro Puls reverse recovery energy	$I_F = I_{\text{Nenn}}, -di_F/dt = 1600\text{A}/\mu\text{s}$ $V_{\text{GE}} = -10\text{V}, T_{vj} = 25^\circ\text{C}, V_R = 600\text{ V}$ $V_{\text{GE}} = -10\text{V}, T_{vj} = 125^\circ\text{C}, V_R = 600\text{ V}$	E_{RQ}	-	1,6	-	mWs
			-	4	-	mWs

Transistor Brems-Chopper/ Transistor Brake-Chopper

min. typ. max.

Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	$V_{\text{GE}} = 15\text{V}, T_{vj} = 25^\circ\text{C}, I_C = 25,0\text{ A}$ $V_{\text{GE}} = 15\text{V}, T_{vj} = 125^\circ\text{C}, I_C = 25,0\text{ A}$	$V_{\text{CE sat}}$	-	2,2	2,55	V
Gate-Schwellenspannung gate threshold voltage	$V_{\text{CE}} = V_{\text{GE}}, T_{vj} = 25^\circ\text{C}, I_C = 1\text{mA}$	$V_{\text{GE(TO)}}$	4,5	5,5	6,5	V
Eingangskapazität input capacitance	$f = 1\text{MHz}, T_{vj} = 25^\circ\text{C}$ $V_{\text{CE}} = 25\text{ V}, V_{\text{GE}} = 0\text{ V}$	C_{ies}	-	1,5	-	nF
Kollektor-Emitter Reststrom collector-emitter cut-off current	$V_{\text{GE}} = 0\text{V}, T_{vj} = 25^\circ\text{C}, V_{\text{CE}} = 1200\text{ V}$ $V_{\text{GE}} = 0\text{V}, T_{vj} = 125^\circ\text{C}, V_{\text{CE}} = 1200\text{ V}$	I_{CES}	-	1,5	500	μA
Gate-Emitter Reststrom gate-emitter leakage current	$V_{\text{CE}} = 0\text{V}, V_{\text{GE}} = 20\text{V}, T_{vj} = 25^\circ\text{C}$	I_{GES}	-	-	300	nA
Schaltverluste und -bedingungen Switching losses and conditions	siehe Datenblatt (Wechselrichter) see datasheet (inverter)	BSM25GP120				

Diode Brems-Chopper/ Diode Brake-Chopper

min. typ. max.

Durchlaßspannung forward voltage	$T_{vj} = 25^\circ\text{C}, I_F = 25,0\text{ A}$ $T_{vj} = 125^\circ\text{C}, I_F = 25,0\text{ A}$	V_F	-	2,1	2,4	V
Schaltverluste und -bedingungen Switching losses and conditions	siehe Datenblatt (Wechselrichter) see datasheet (inverter)	BSM15GP120				

NTC-Widerstand/ NTC-Thermistor

min. typ. max.

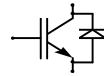
Nennwiderstand rated resistance	$T_C = 25^\circ\text{C}$	R_{25}	-	5	-	kΩ
Abweichung von R_{100} deviation of R_{100}	$T_C = 100^\circ\text{C}, R_{100} = 493\text{ Ω}$	$\Delta R/R$	-5		5	%
Verlustleistung power dissipation	$T_C = 25^\circ\text{C}$	P_{25}			20	mW
B-Wert B-value	$R_2 = R_1 \exp [B(1/T_2 - 1/T_1)]$	$B_{25/50}$		3375		K

Technische Information / Technical Information

IGBT-Module
IGBT-Modules

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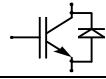


Thermische Eigenschaften / Thermal properties

				min.	typ.	max.
Innerer Wärmewiderstand thermal resistance, junction to case	Gleichr. Diode/ Rectif. Diode Trans. Wechsr./ Trans. Inverter Diode Wechsr./ Diode Inverter Trans. Bremse/ Trans. Brake Diode Bremse/ Diode Brake	R_{thJC}	- - - - -	- - - - -	0,65 0,35 0,55 0,55 1,2	K/W K/W K/W K/W K/W
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	Gleichr. Diode/ Rectif. Diode Trans. Wechsr./ Trans. Inverter Diode Wechsr./ Diode Inverter	R_{thCK}	$\lambda_{Paste}=1W/m^*K$ $\lambda_{grease}=1W/m^*K$	- - -	0,04 0,02 0,04	- - -
Höchstzulässige Sperrschichttemperatur maximum junction temperature		$T_{vj\ max}$		-	150	°C
Betriebstemperatur operation temperature		$T_{vj\ op}$		-40	-	125 °C
Lagertemperatur storage temperature		T_{stg}		-40	-	125 °C

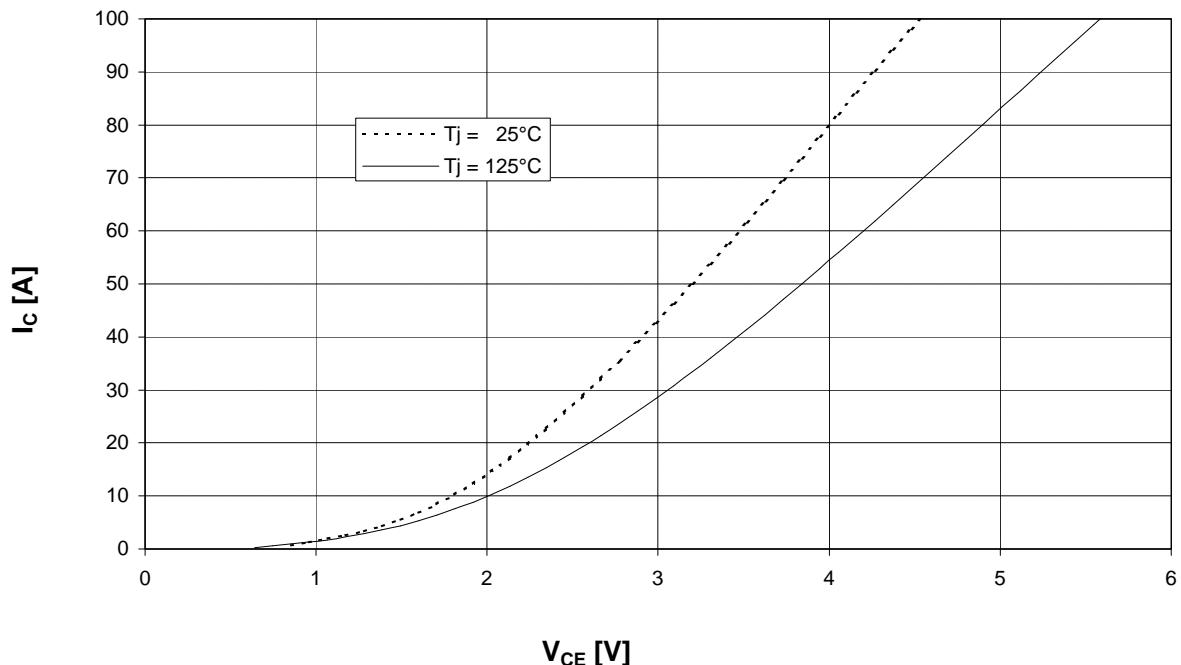
Mechanische Eigenschaften / Mechanical properties

Innere Isolation internal insulation			Al_2O_3	
CTI comperative tracking index			225	
Anzugsdrehmoment f. mech. Befestigung mounting torque		M	3 ±10%	Nm
Gewicht weight		G	300	g

**Ausgangskennlinienfeld Wechselr. (typisch)****Output characteristic Inverter (typical)**

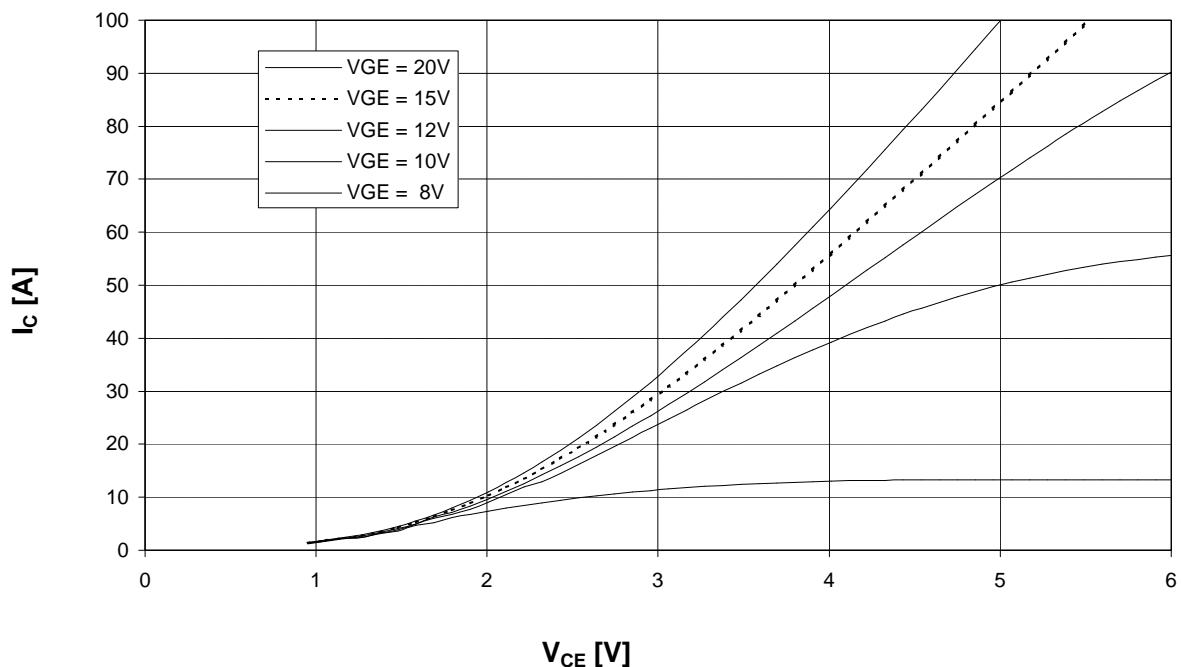
$$I_C = f(V_{CE})$$

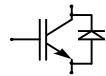
$$V_{GE} = 15 \text{ V}$$

**Ausgangskennlinienfeld Wechselr. (typisch)****Output characteristic Inverter (typical)**

$$I_C = f(V_{CE})$$

$$T_{vj} = 125^\circ\text{C}$$



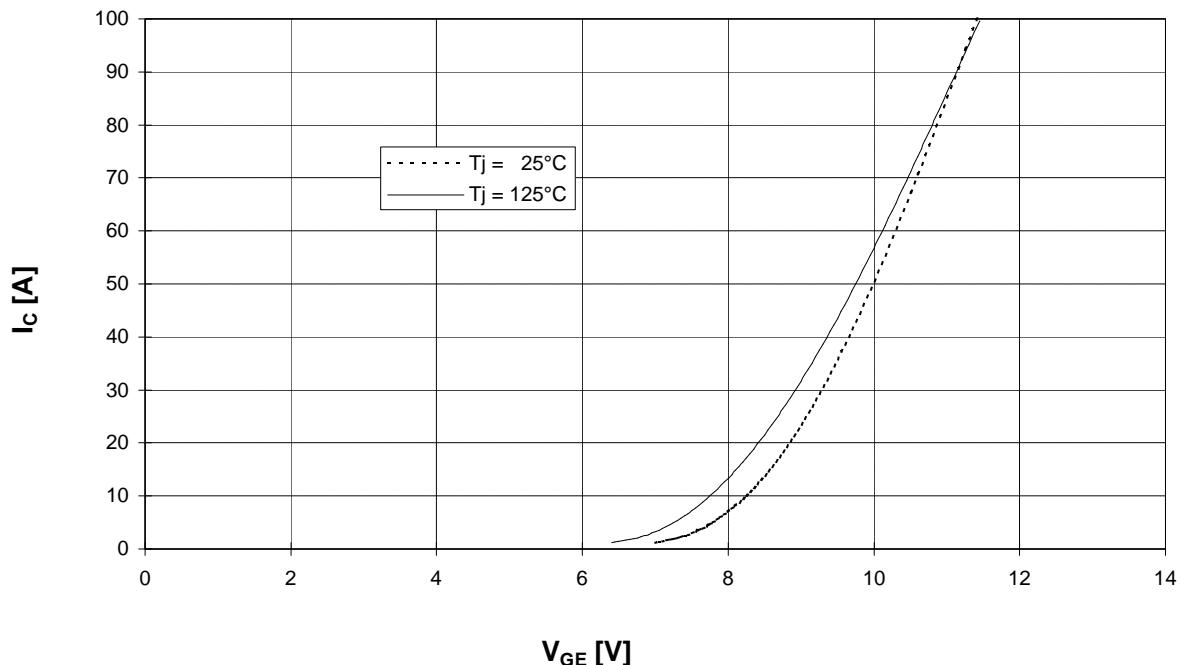


Übertragungscharakteristik Wechselr. (typisch)

Transfer characteristic Inverter (typical)

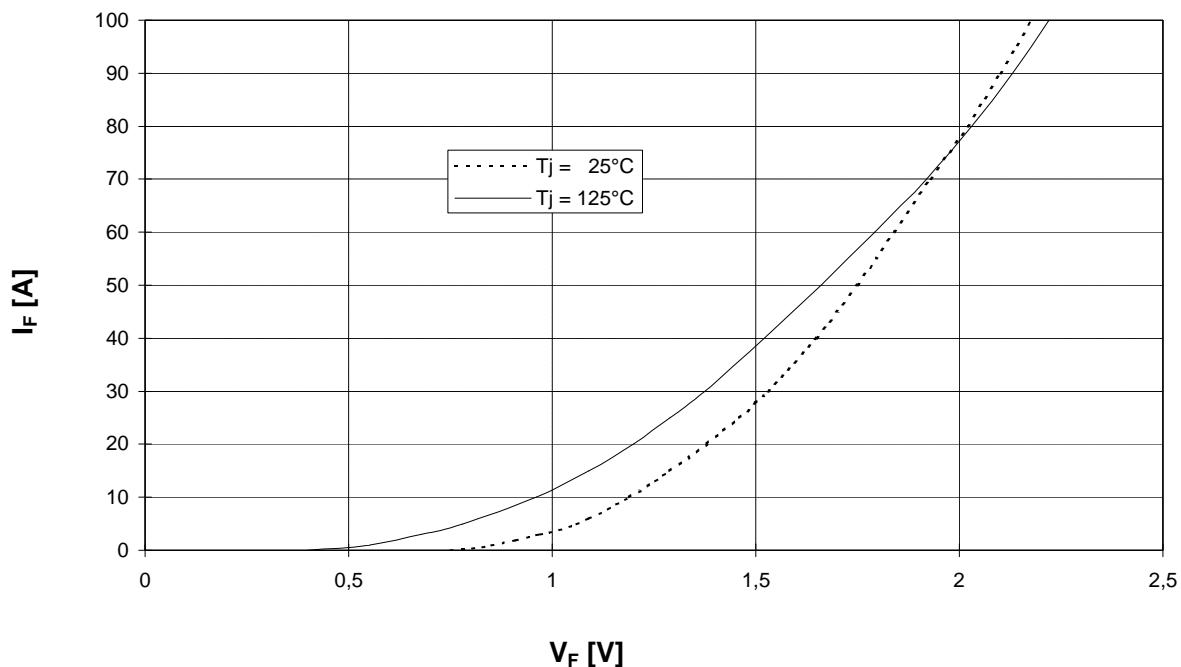
$$I_C = f(V_{GE})$$

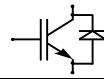
$$V_{CE} = 20 \text{ V}$$



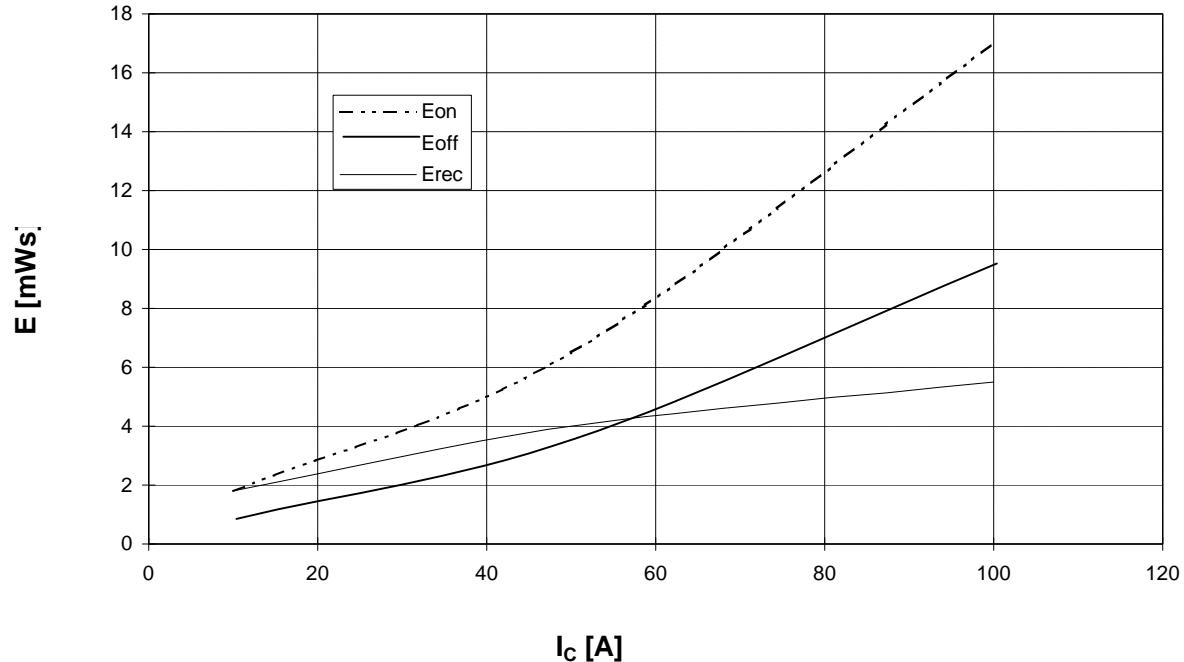
Durchlaßkennlinie der Freilaufdiode Wechselr. (typisch)

Forward characteristic of FWD Inverter (typical)

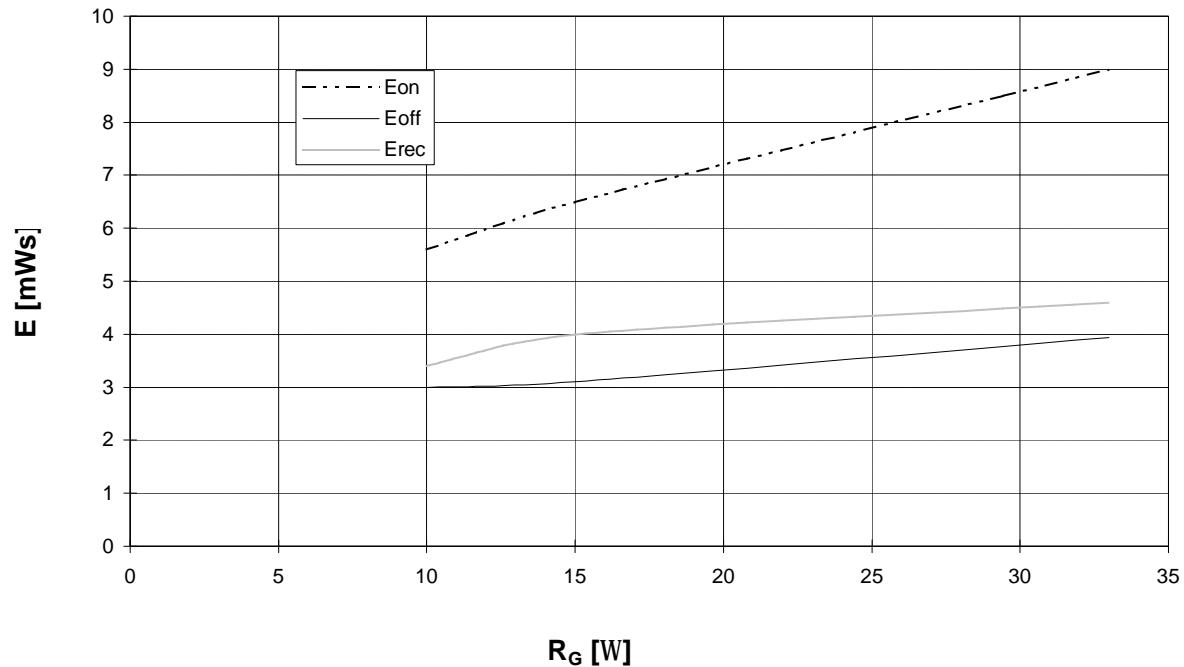


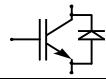


Schaltverluste Wechselr. (typisch) $E_{on} = f(I_c)$, $E_{off} = f(I_c)$, $E_{rec} = f(I_c)$ $V_{CC} = 600\text{ V}$
Switching losses Inverter (typical) $E_{on} = f(R_G)$, $E_{off} = f(R_G)$, $E_{rec} = f(R_G)$ $T_j = 125^\circ\text{C}$, $V_{GE} = \pm 15\text{ V}$, $R_{Gon} = R_{Goff} = 15\text{ Ohm}$

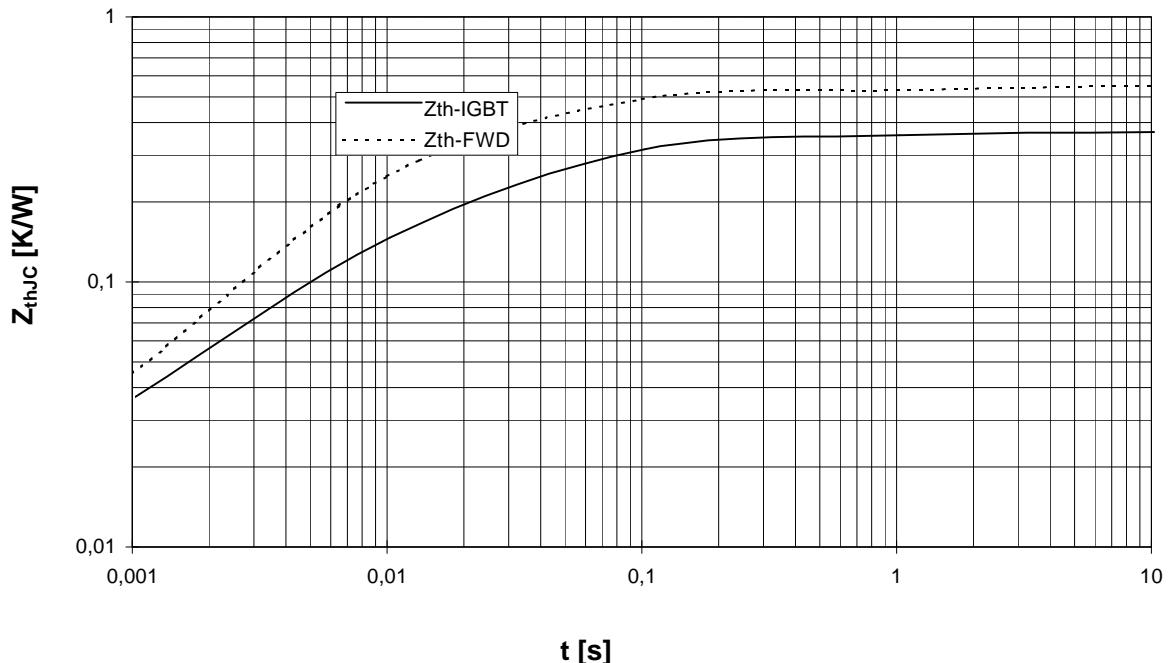


Schaltverluste Wechselr. (typisch) $E_{on} = f(R_G)$, $E_{off} = f(R_G)$, $E_{rec} = f(R_G)$ $T_j = 125^\circ\text{C}$, $V_{GE} = \pm 15\text{ V}$, $I_c = I_{\text{nenn}}$, $V_{CC} = 600\text{ V}$
Switching losses Inverter (typical) $E_{on} = f(R_G)$, $E_{off} = f(R_G)$, $E_{rec} = f(R_G)$ $T_j = 125^\circ\text{C}$, $V_{GE} = \pm 15\text{ V}$, $I_c = I_{\text{nenn}}$, $V_{CC} = 600\text{ V}$

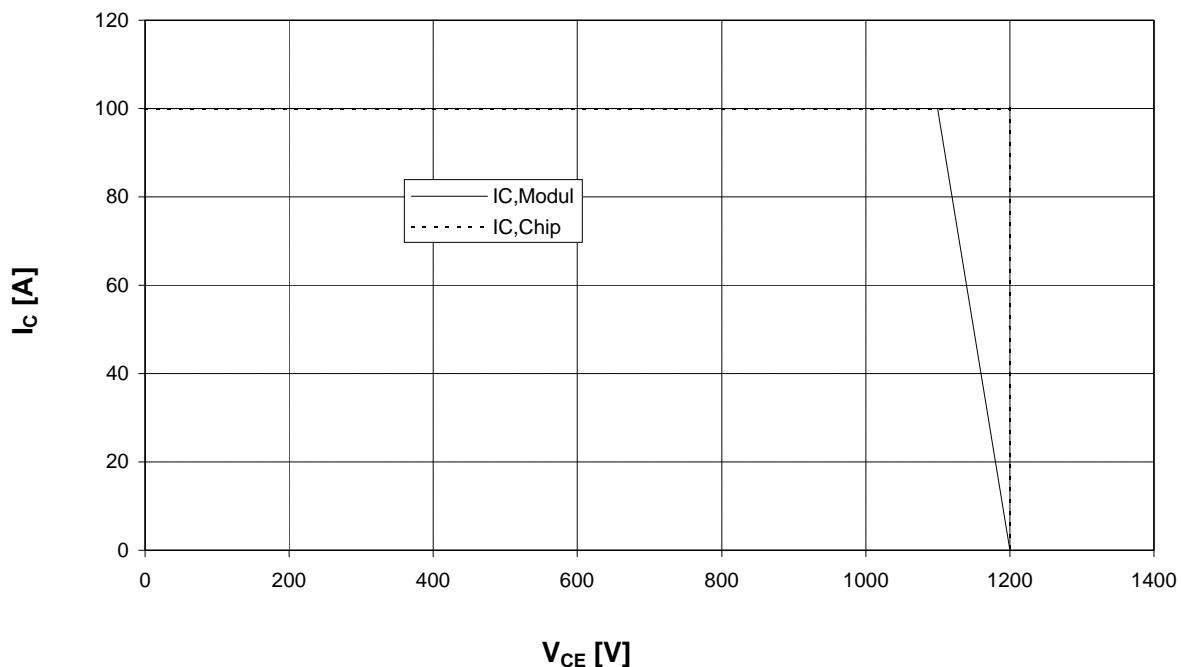


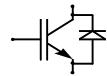
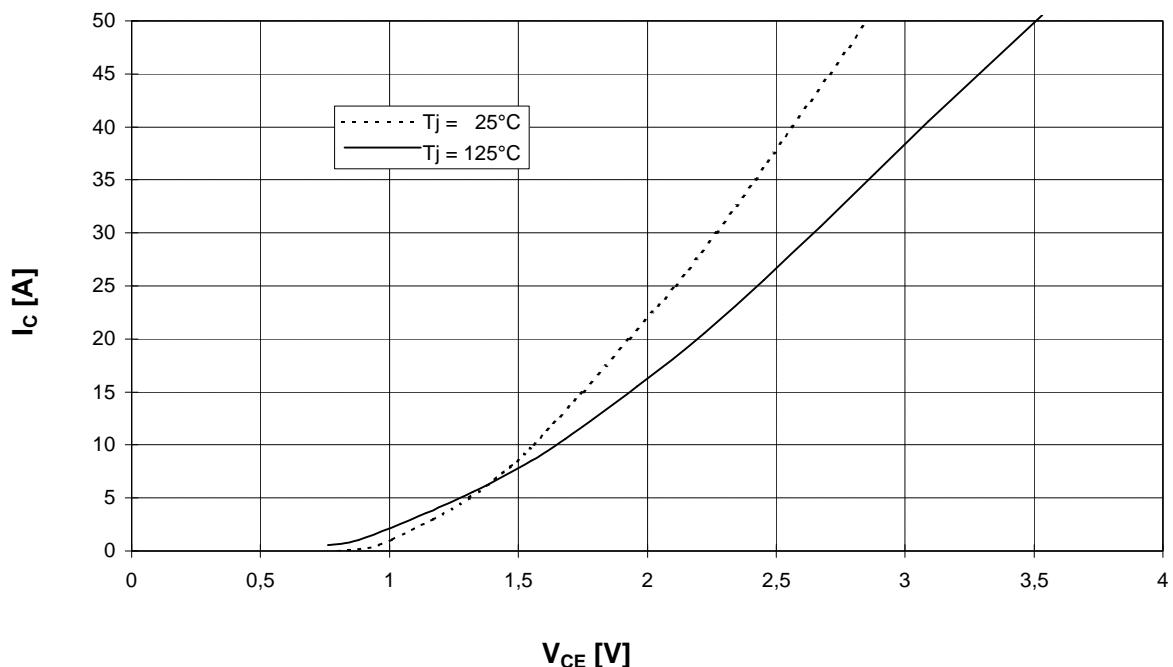
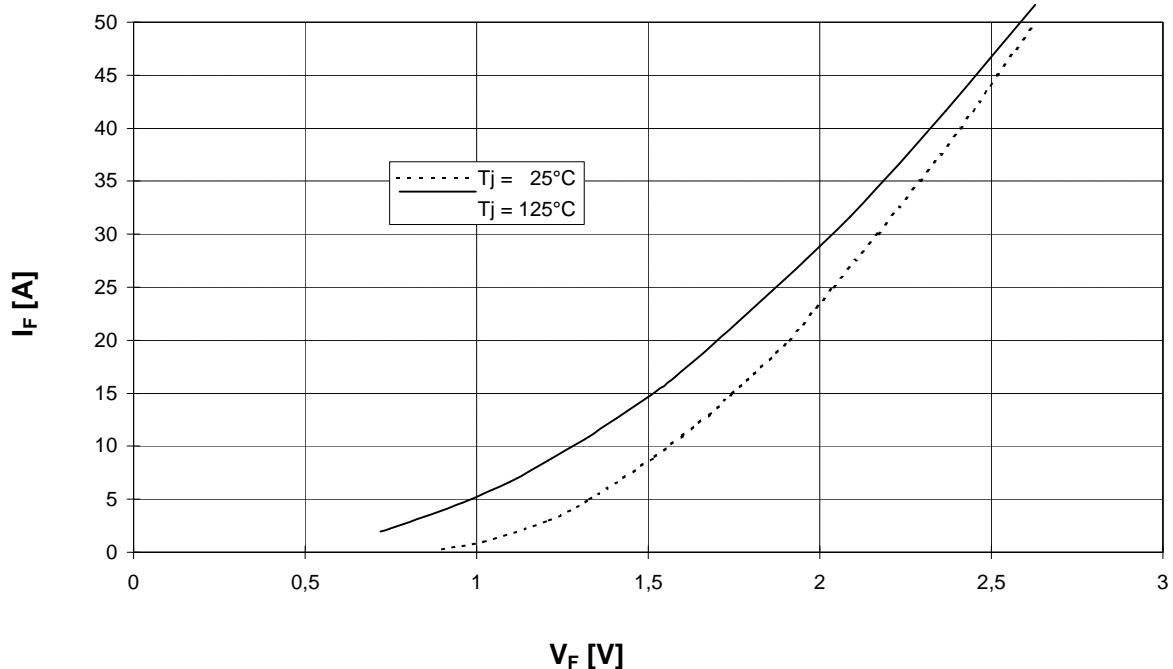


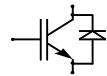
Transienter Wärmewiderstand Wechselr. $Z_{thJC} = f(t)$
Transient thermal impedance Inverter



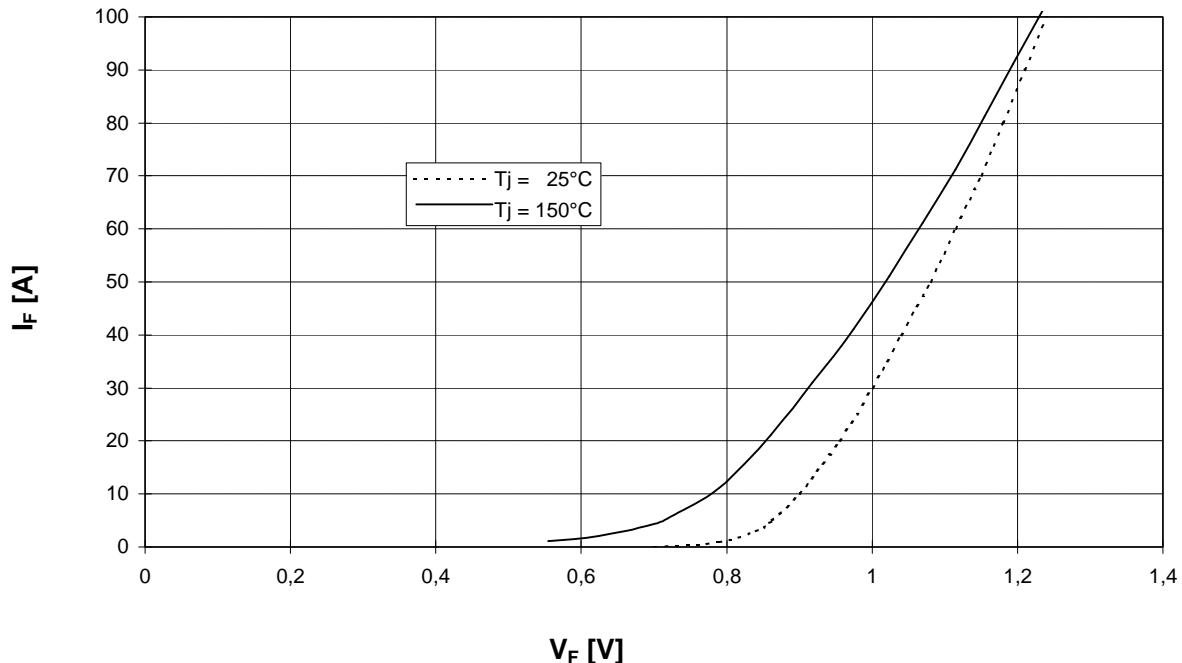
Sicherer Arbeitsbereich Wechselr. (RBSOA) $I_C = f(V_{CE})$
Reverse bias safe operating area Inverter (RBSOA) $T_{vi} = 125^\circ\text{C}$, $V_{GE} = \pm 15\text{V}$, $R_G = 150\text{Ohm}$



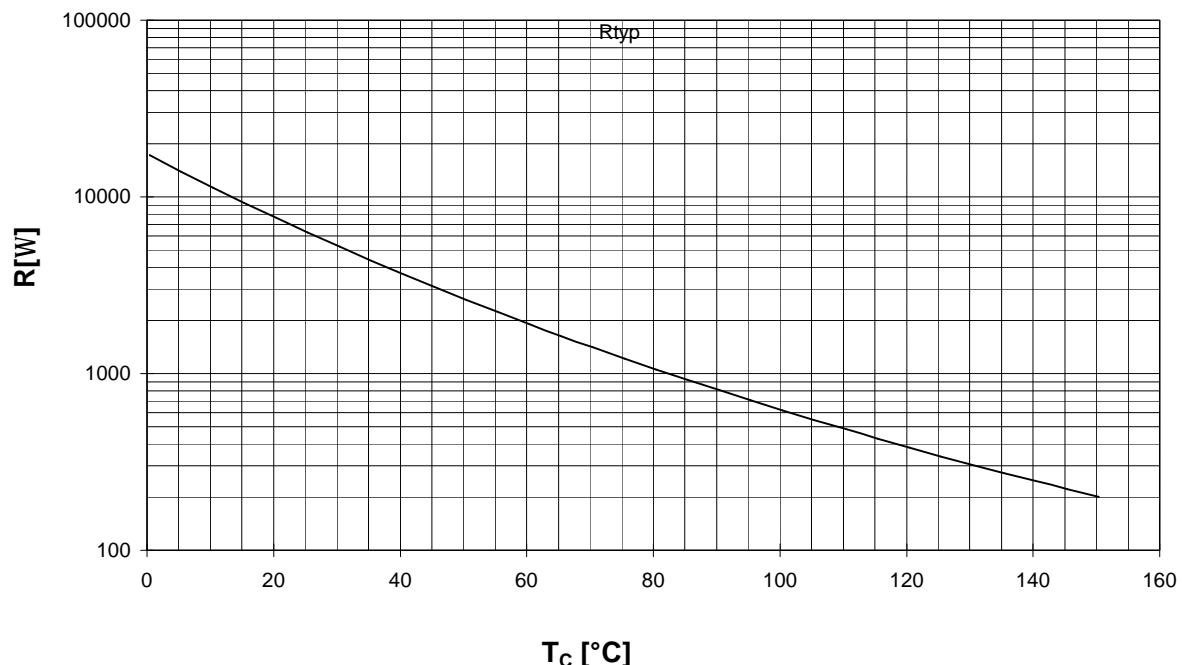
**Ausgangskennlinienfeld Brems-Chopper-IGBT (typisch) $I_C = f(V_{CE})$** **Output characteristic brake-chopper-IGBT (typical)** $V_{GE} = 15 \text{ V}$ **Durchlaßkennlinie der Brems-Chopper-Diode (typisch) $I_F = f(V_F)$** **Forward characteristic of brake-chopper-FWD (typical)**

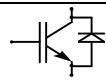
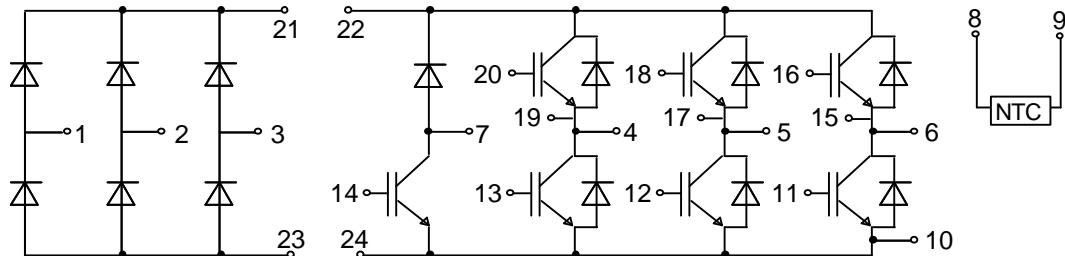
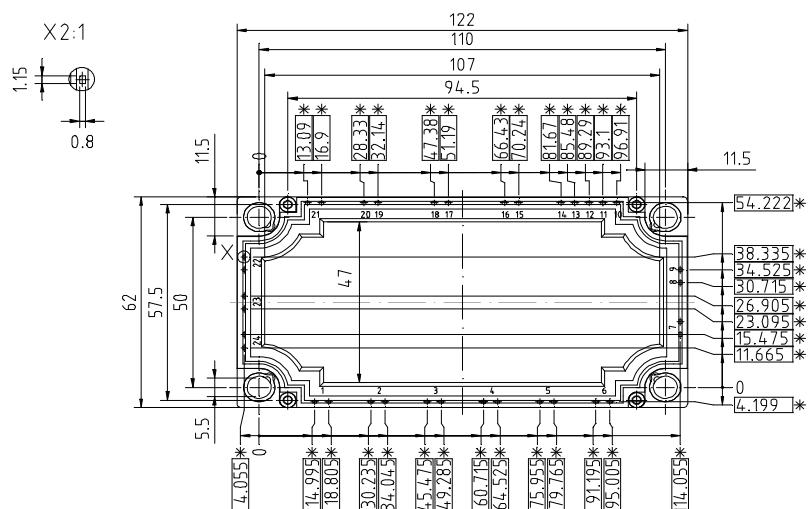
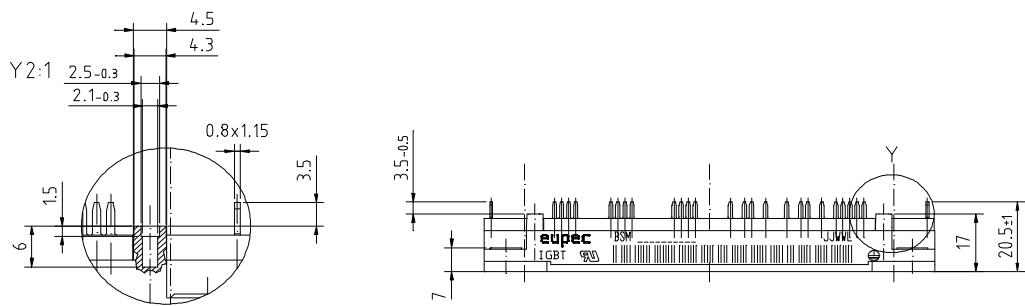


Durchlaßkennlinie der Gleichrichterdiode (typisch) $I_F = f(V_F)$
 Forward characteristic of Rectifier Diode (typical)



NTC- Temperaturkennlinie (typisch) $R = f(T)$
 NTC- temperature characteristic (typical)



**Schaltplan/ Circuit diagram****Gehäuseabmessungen/ Package outlines**

Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert. Sie gilt in Verbindung mit den zugehörigen Technischen Erläuterungen.

This technical information specifies semiconductor devices but promises no characteristics. It is valid in combination with the belonging technical notes.